

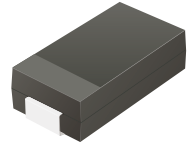
US8AC-HF Thru. US8MC-HF

Reverse Voltage: 50 to 1000 Volts

Forward Current: 8 Amp

RoHS Device

Halogen Free



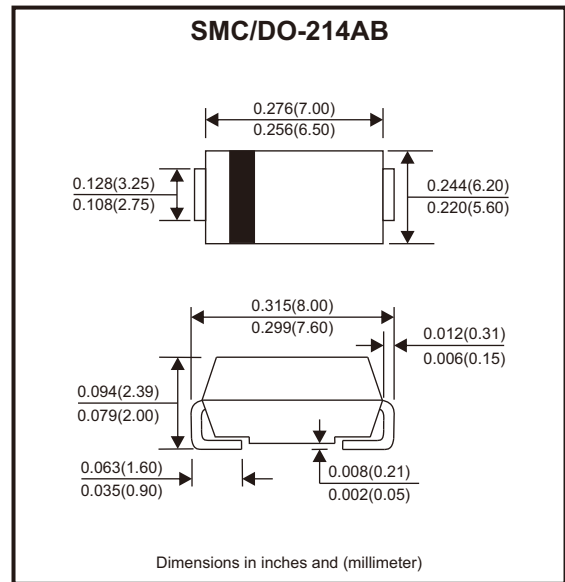
Features

- For surface mounted applications.
- Low profile package.
- Glass passivated chip junction.

Mechanical data

- Case: SMC
- Terminals: Solderable per MIL-STD-750, method 2026.

Circuit Diagram



Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20%

Parameter	Symbols	US8AC -HF	US8BC -HF	US8DC -HF	US8GC -HF	US8JC -HF	US8KC -HF	US8MC -HF	Units
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _c =100°C	I _{F(AV)}	8							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	150							A
Max. instantaneous forward voltage at 8A	V _F	1.0			1.3	1.7			V
Maximum DC reverse current T _a = 25°C at rated DC reverse voltage T _a =125°C	I _R	10 100							μA
Typical junction capacitance at V _R = 4V, f = 1MHz	C _j	65				55			pF
Maximum reverse recovery time (Note 1)	t _{rr}	50				80			ns
Typical thermal resistance (Note 2)	R _{θJA}	35							°C/W
Operating and storage temperature range	T _j , T _{stg}	-55 ~ +150							°C

Notes: 1. Measured with $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$.

2. P.C.B. mounted with 2.0" x 2.0" (5 x 5 cm) copper pad areas.

Company reserves the right to improve product design , functions and reliability without notice.

REV:A

Rating and Characteristic Curves (US8AC-HF Thru. US8MC-HF)

Fig.1 - Max. Average Forward Current Rating

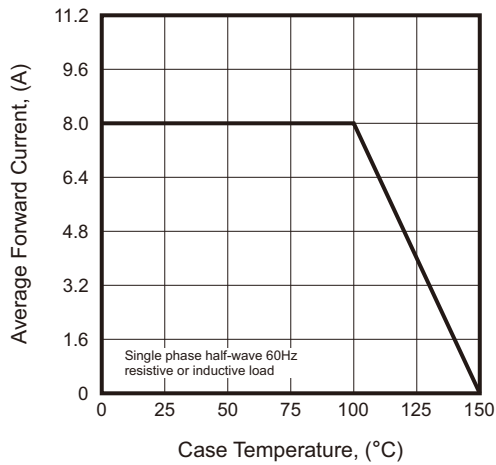


Fig.2 - Typical Reverse Characteristics

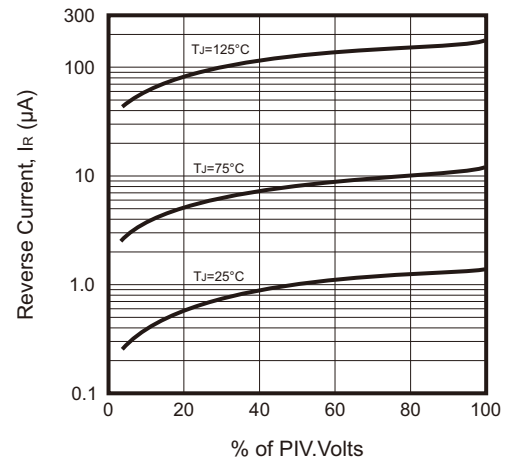


Fig.3 - Typical Forward Characteristic

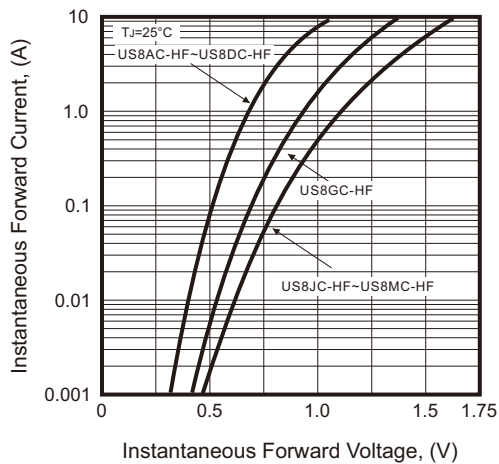


Fig.4 - Typical Junction Capacitance

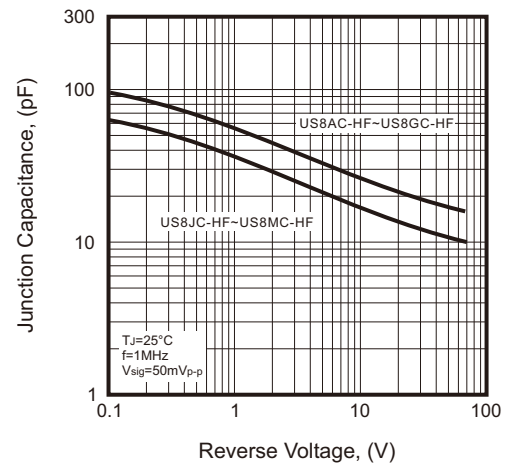
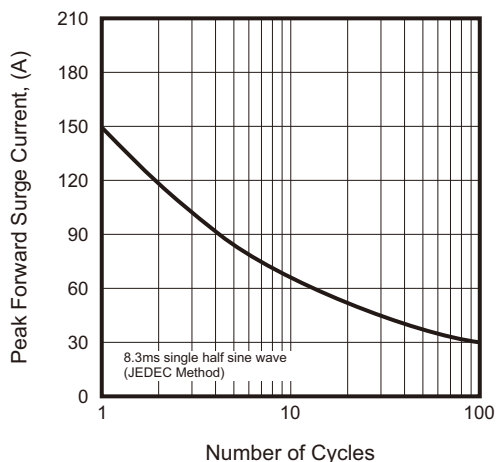
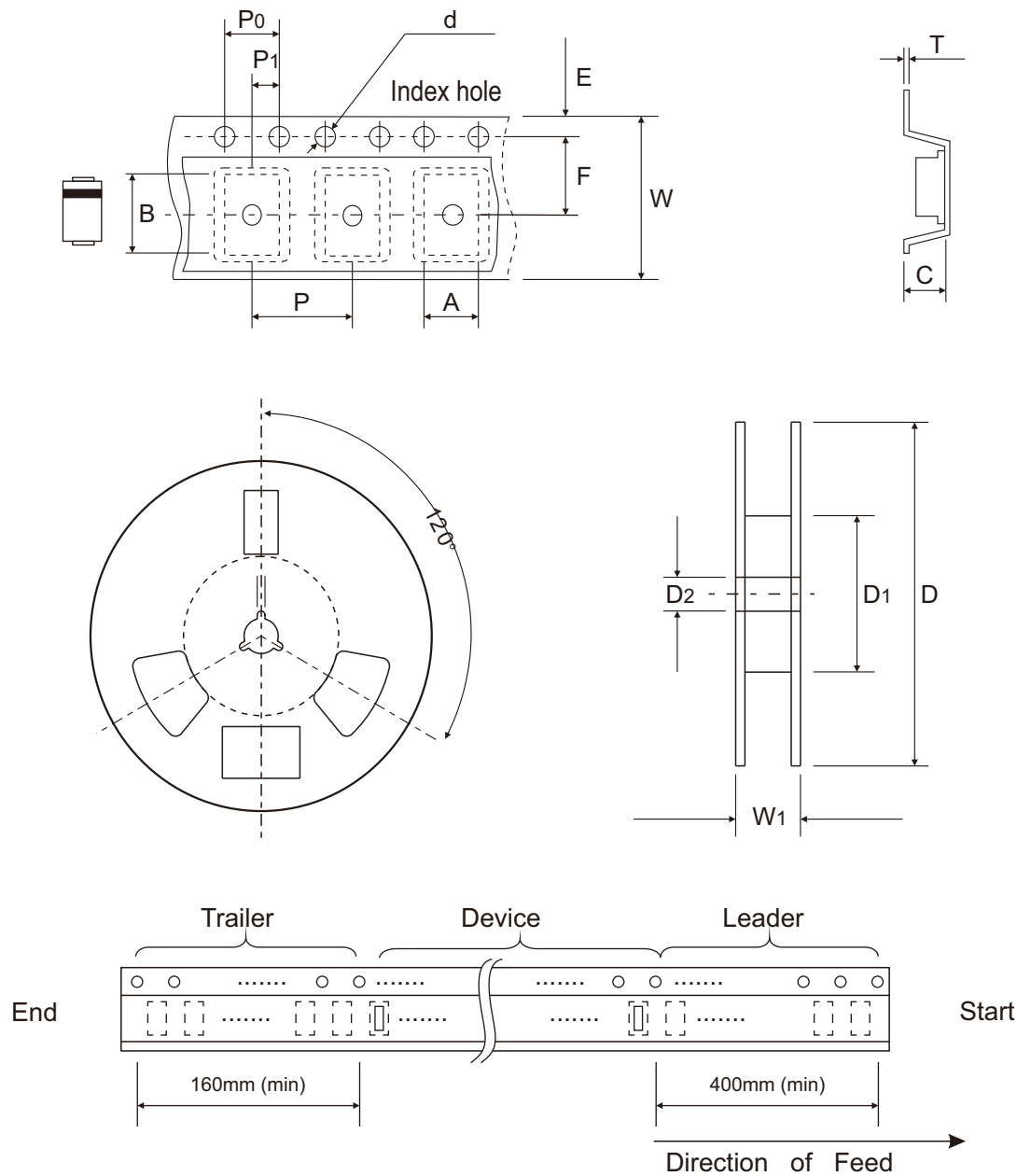


Fig.5 - Maximum Non-Repetitive Peak Forward Surge Current



Reel Taping Specification

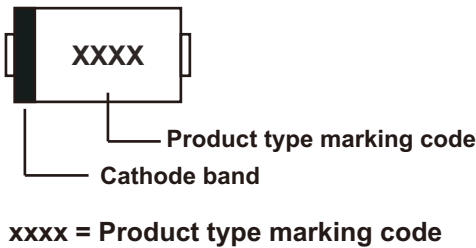


DO-214AB (SMC)	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	6.22 ± 0.10	8.31 ± 0.10	2.49 ± 0.10	1.55 ± 0.05	330 ± 2.00	100.00 ± 1.00	13.00 ± 0.20
	(inch)	0.245 ± 0.004	0.327 ± 0.004	0.098 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	3.937 ± 0.039	0.512 ± 0.008

DO-214AB (SMC)	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	7.50 ± 0.10	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	0.28 ± 0.02	16.00 ± 0.30	21.00 + 2.00 - 1.00
	(inch)	0.069 ± 0.004	0.295 ± 0.004	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.011 ± 0.001	0.630 ± 0.012	0.827 + 0.079 - 0.039

Marking Code

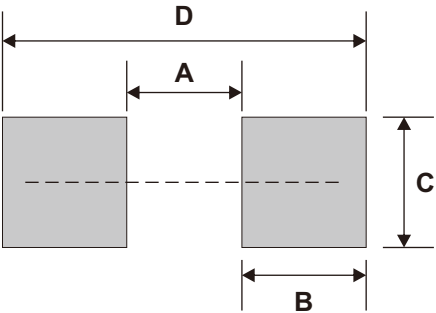
Part Number	Marking Code
US8AC-HF	US8A
US8BC-HF	US8B
US8DC-HF	US8D
US8GC-HF	US8G
US8JC-HF	US8J
US8KC-HF	US8K
US8MC-HF	US8M



Suggested PAD Layout

SIZE	DO-214AB (SMC)	
	(mm)	(inch)
A	3.80	0.150
B	4.10	0.161
C	4.30	0.169
D	12.00	0.472

Note: 1. The pad layout is for reference purpose only.



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
DO-214AB (SMC)	3,000	13

Mouser Electronics

Authorized Distributor

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[US8GC-HF](#) [US8JC-HF](#) [US8KC-HF](#) [US8MC-HF](#) [US8AC-HF](#) [US8BC-HF](#) [US8DC-HF](#)